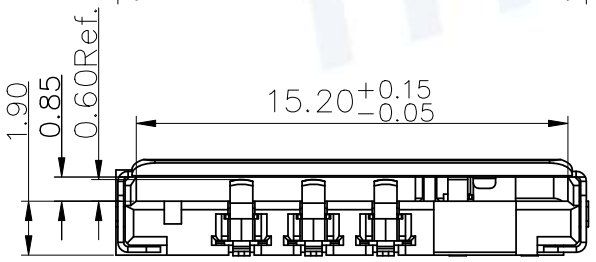
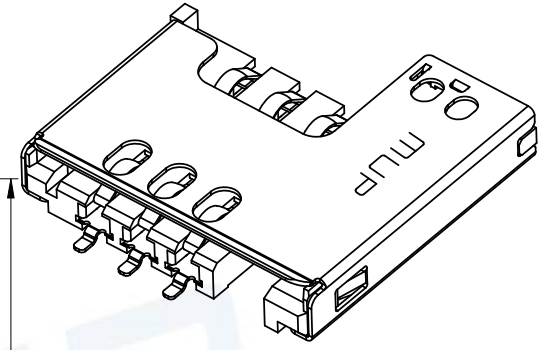
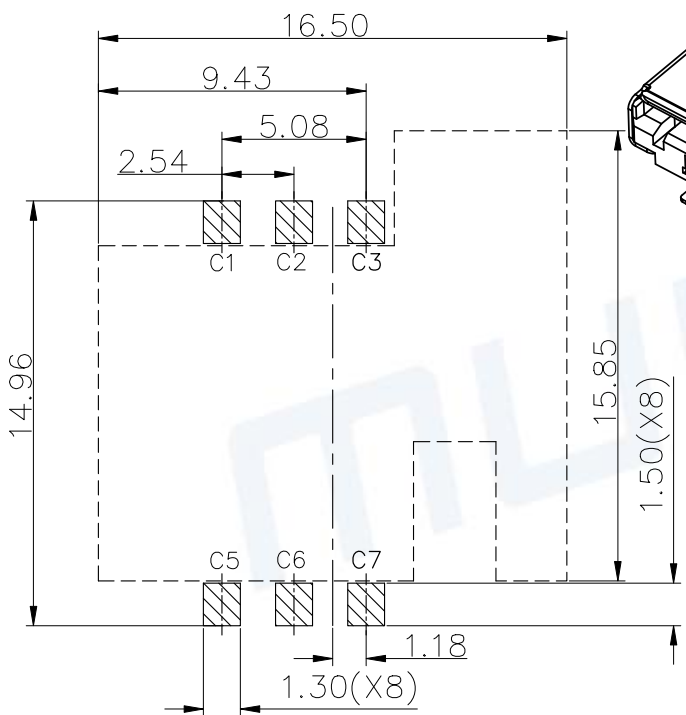
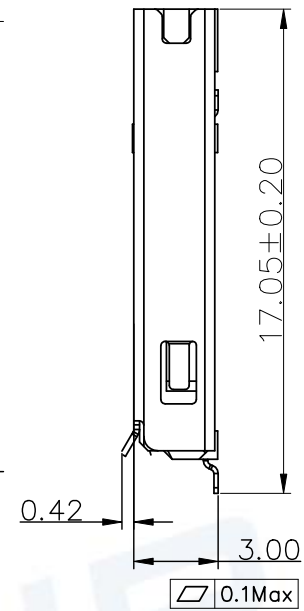
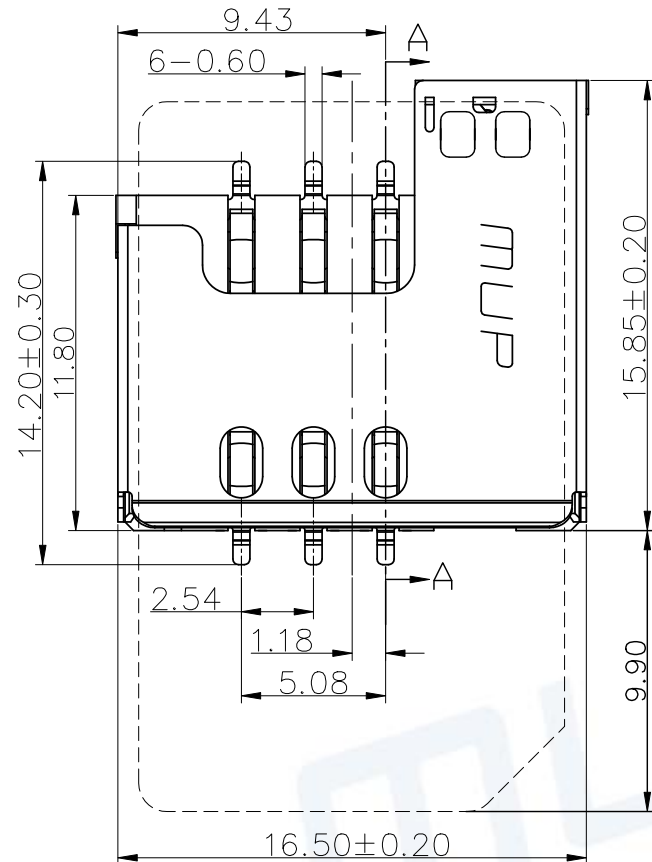


REV.	DESCRIPTION OF REVISIONS	APPR.	DRAW.	RELEASE	DATE
X1	NEW REVISION				Zoey Aug.14.2008
X2					



TECHNICAL CHARACTERISTICS

- General Characteristics**
 Dimensions: 15.85LX16.50WX3.00H mm
 Weight: Approx 0.78±0.2g
 Durability: 5,000 cycles min.
- Electrical Characteristics**
 Contact resistance:
 50mΩ typical 100mΩ max
 Insulation resistance:
 >1000MΩ/500V DC
- Solderability**
 Vapor phase: 215°C, 30sec. Max
 IR reflow: 250°C, 5sec. Max
 Manual soldering: 370°C, 3sec. Max
- Environmental Characteristics**
 Operating temperature:
 -40°C~+85°C
 Operating humidity: 10%~+95%RH

RECOMMENDED P.C.B LAYOUT
 COMPONENT SIDE(TOLERANCE ±0.05)

ITEM	PART NAME	Q'TY	MATERIAL	FINISH
1	BASE	1	Hi-temp Thermoplastic	Black UL94V-0
2	COVER	1	Stainless Steel	
3	DATA CONTACT	6	Copper Alloy	Contact area:Gold plated

Unless otherwise specified, other tolerance are:

X	±0.35	X*	±5*
X.X	±0.25	X.X*	±4*
X.XX	±0.15	X.XX*	±3*
X.XXX	±0.10	X.XXX*	±2*

MUP MUP INDUSTRIAL CO.,LTD.

NAME: **SIM Card Connector**

MODEL NO: **MUP-C729-2**

TYPE: **Without post / Normally open**

PROJ.	UNIT	SCALE	DRAWN	Zoey Aug.14.2008	DWG NO.:
⊕	mm	1:1	CHECKED	Jimmy Aug.14.2008	DWG-MUP-C729-2
CUSTOMER DRAWING			APPROVAL	Simon Aug.14.2008	SHEET
					1/1
					REVISION
					X1

